

use of active terminations at both ends of every cable segment in a SCSI system with single–ended drivers and receivers. The DS2114 SCSI Terminator, which is fully compliant with these standards, enables the designer to gain the benefits of active termination: greater immunity to voltage drops on the TERMPWR (TER-Mination PoWeR) line, enhanced high–level noise imquiescent current consumption. The DS2114 integrates a regulator and nine precise 110 ohms termination resistors into a monolithic IC. The DS2114 is intended for cable end terminator assemblies and devices where the terminators do not need to be isolated from the SCSI bus.



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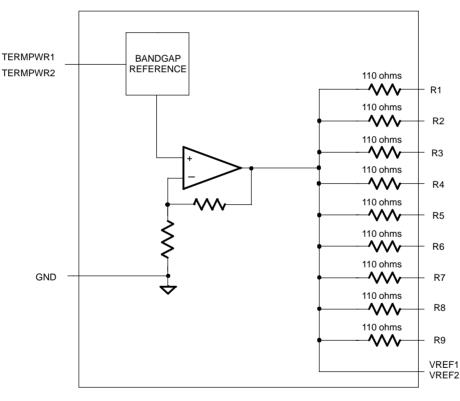
DS2114

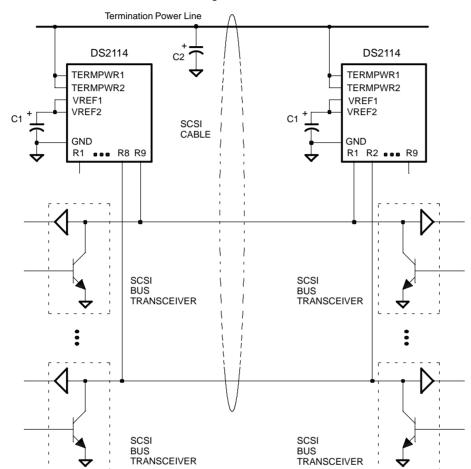
### FUNCTIONAL DESCRIPTION

The DS2114 consists of a bandgap reference, buffer amplifier, and nine termination resistors (Figure 1). The bandgap reference circuit produces a precise 2.55 volts level which is fed to a buffer amplifier. The buffer produces a 2.85 volts level and is capable of sourcing at least 24 mA into each of the termination resistors when the signal line is low (active). When the driver for a given signal line turns off, the terminator will pull the signal line to 2.85 volts (quiescent state). To handle actively negated SCSI signals, the buffer can sink at least 200 mA and  $V_{ref}$  will move less than 60 mV. When all lines settle in the quiescent state, the regulator will consume about 2.5 mA.

To ensure proper operation, both the TERMPWR1 and TERMPWR2 pins must be connected to the SCSI bus TERMPWR line and both the VREF1 and VREF2 pins must be tied together externally. Each DS2114 requires a 4.7  $\mu$ F capacitor connected between the VREF pins and ground. Figure 2 details a typical SCSI bus configuration. In an 8–bit wide SCSI bus arrangement ("A" Cable), two DS2114's would be needed at each end of the SCSI cable in order to terminate the 18 active signal lines. In a 16–bit wide SCSI bus arrangement ("P" Cable), three DS2114's would be needed at each end of the SCSI cable in order to terminate the 27 active signal lines.







# TYPICAL SCSI BUS CONFIGURATION Figure 2

### NOTES:

1. C1 = 4.7  $\mu$ F tantalum

C2 = 2.2  $\mu$ F tantalum or 4.7  $\mu$ F aluminum

- 2. If the DS2114 is to be embedded into a peripheral that will act as a target on a SCSI bus, it is recommended that TERMPWR be derived from the SCSI cable, not generated locally. In this configuration, if a power failure occurs in the peripheral, it will not affect the bus.
- A high frequency bypass capacitor (0.1 μF recommended) can be added in parallel to C1 for applications using fast rise/fall time drivers.

DS2114

DS2114

# PIN DESCRIPTION Table 1

DS2114Z PIN	SYMBOL	DESCRIPTION					
1	TERMPWR1	<b>Termination Power 1.</b> Should be connected to the SCSI TERMPWR line. Must be decoupled with either a 2.2 $\mu$ F or 4.7 $\mu$ F. See Figure 2.					
2	R1	Signal Termination 1. 110 ohms termination.					
3	R2	Signal Termination 2. 110 ohms termination.					
4	R3	Signal Termination 3. 110 ohms termination.					
5	R4	Signal Termination 4. 110 ohms termination.					
6	R5	Signal Termination 5. 110 ohms termination.					
7	VREF1	<b>Reference Voltage 1.</b> Must be externally connected directly to the VREF2 pin. Must be decoupled with a 4.7 $\mu$ F capacitor as shown in Figure 2.					
8	GND	Ground. Signal ground; 0.0 volts.					
9	TERMPWR2	<b>Termination Power 2.</b> Should be connected to the SCSI TERMPWR line. Must be decoupled with either a 2.2 $\mu$ F or 4.7 $\mu$ F. See Figure 2.					
11	R6	Signal Termination 6. 110 ohms termination.					
12	R7	Signal Termination 7. 110 ohms termination.					
13	R8	Signal Termination 8. 110 ohms termination.					
14	R9	Signal Termination 9. 110 ohms termination.					
10, 16	NC	No Connect. Do not connect any signal to these pins.					
15	VREF2	<b>Reference Voltage 2.</b> Must be externally connected directly to the VREF1 pin. Must be decoupled with a 4.7 $\mu$ F capacitor as shown in Figure 2.					

## **ABSOLUTE MAXIMUM RATINGS\***

Voltage on Any Pin Relative to Ground Operating Temperature Storage Temperature Soldering Temperature

-1.0V to +7.0V 0°C to 70°C -55°C to +125°C 260°C for 10 seconds

This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

The Dallas Semiconductor DS2114 is built to the highest quality standards and manufactured for long term reliability. All Dallas Semiconductor devices are made using the same quality materials and manufacturing methods. However, the DS2114 is not exposed to environmental stresses, such as burn-in, that some industrial applications require. For specific reliability information on this product, please contact the factory in Dallas at (972) 371-4448.

RECOMMENDED OPERATING CONDITIONS					(0°C to 70°C)		
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES	
TERMPWR Voltage	V <sub>TP</sub>	4.00		5.50	V		

DC CHARACTERISTICS (0)						0°C to 70°C
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
TERMPWR Current	I <sub>TP</sub> I <sub>TP</sub>		5	250 8	mA mA	1, 3 1, 4
Termination Resistance	R <sub>TERM</sub>	110		116	ohms	1, 2
Die Thermal Shutdown	T <sub>SD</sub>	150			°C	1, 5
Termination Capacitance	CT		5.0		pF	1, 2, 5

### **REGULATOR CHARACTERISTICS**

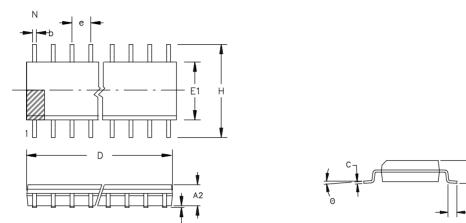
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Output Voltage	V <sub>REF</sub>	2.7	2.85	3.0	V	1, 2
Drop Out Voltage	V <sub>DROP</sub>		0.75	1.0	V	3, 5
Line Regulation	LI <sub>REG</sub>		1.0	2.0	%	1, 4
Output Current	I <sub>OUT</sub>			24.0	mA	6
Load Regulation	LO <sub>REG</sub>		1.3	3.0	%	1, 3
Current Limit	I <sub>LIM</sub>	280		500	mA	1
Sink Current	I <sub>SINK</sub>	200			mA	1

#### NOTES:

- 1. 4.00 volts < TERMPWR < 5.50 volts.
- 2. 0.0 volts < signal lines < TERMPWR.
- 3. All signal lines = 0.0 volts.
- 4. All signal lines open.
- 5. Guaranteed by design; not production tested.
- 6.  $V_{SIGNAL} = 0.2V.$

(0°C to 70°C)

DS2114



DS2114Z SCSI TERMINATOR 16-PIN SOIC (150 MIL)

16-PIN

МАХ

0.069 1.75

0.010 0.25

0.062 1.57

0.020 0.50

0.011 0.28

0.393 9.98

0.158 4.01

0.244 6.20

0.050 0.89

8°

0.050 BSC 1.27 BSC

MIN

0.053 1.35

0.004 0.10

0.048 1.24

0.012 0.30

0.007 0.17

0.386 9.80

0.150 3.81

0.230 5.84

0.016 0.40

0°

PKG DIM

A IN. MM

A1 IN. MM

A2 IN. MM

b IN. MM

C IN MM

d in. MM

e IN. MM E1 IN. MM

H IN. MM

L IN. MM

Θ